

United States Patent and Trademark Office

UNITED STATES DEPARTMENT OF COMMERCE United States Patent and Trademark Office Address: COMMISSIONER OF PATENTS AND TRADEMARKS Washington, D.C. 20231 www.uspto.gov

APPLICATION NO.	FI	LING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.
09/714,373	09/714,373 11/16/2000		David J. Alcoe	END92000094US1	5007
5409	7590	11/29/2001			
ARLEN L.			EXAMINER		
SCHMEISEI 3 LEAR JET SUITE 201	•	V & WATTS	LINDINGER, MICHAEL L		
LATHAM, NY 12110				ART UNIT	PAPER NUMBER
•	,			2841	
				DATE MAILED: 11/29/2001	

Please find below and/or attached an Office communication concerning this application or proceeding.

	Application No.	.pplicant(s)					
÷ ','		ALCOE, DAVID J.					
Offic Action Summary	09/714,373 Examiner	Art Unit					
_	Michael L. Lindinger	2841					
The MAILING DATE of this communication appe							
Period for Reply							
A SHORTENED STATUTORY PERIOD FOR REPLY THE MAILING DATE OF THIS COMMUNICATION. - Extensions of time may be available under the provisions of 37 CFR 1.136 after SIX (6) MONTHS from the mailing date of this communication. - If the period for reply specified above is less than thirty (30) days, a reply vearing to reply is specified above, the maximum statutory period will for reply within the set or extended period for reply will, by statute, or any reply received by the Office later than three months after the mailing dearned patent term adjustment. See 37 CFR 1.704(b). Status	oi(a). In no event, however, may a reply within the statutory minimum of thirty (3 I apply and will expire SIX (6) MONTH cause the application to become ABAN	y be timely filed 30) days will be considered timely. S from the mailing date of this communication. IDONED (35 U.S.C. § 133).					
1) Responsive to communication(s) filed on							
2a) ☐ This action is FINAL . 2b) ☑ This	action is non-final.						
	Since this application is in condition for allowance except for formal matters, prosecution as to the merits is closed in accordance with the practice under <i>Ex parte Quayle</i> , 1935 C.D. 11, 453 O.G. 213.						
Disposition of Claims							
4) Claim(s) 1-41 is/are pending in the application.							
4a) Of the above claim(s) is/are withdrawn	n from consideration.						
5) Claim(s) is/are allowed.							
6)⊠ Claim(s) <u>1-41</u> is/are rejected.							
7) Claim(s) is/are objected to.	7) Claim(s) is/are objected to.						
8) Claim(s) are subject to restriction and/or	election requirement.						
Application Papers							
9) The specification is objected to by the Examiner.							
10) ☐ The drawing(s) filed on is/are: a) ☐ accepte	•						
Applicant may not request that any objection to the							
11) The proposed drawing correction filed oni		approved by the Examiner.					
If approved, corrected drawings are required in reply to this Office action. 12) The oath or declaration is objected to by the Examiner.							
,	IIIIei.						
Priority under 35 U.S.C. §§ 119 and 120	oriority under 25 II.C.C. S. 1	10(a) (d) or (f)					
13) Acknowledgment is made of a claim for foreign priority under 35 U.S.C. § 119(a)-(d) or (f).							
a) All b) Some * c) None of:							
 1. Certified copies of the priority documents have been received. 2. Certified copies of the priority documents have been received in Application No 							
2. Certified copies of the priority documents have been received in Application No3. Copies of the certified copies of the priority documents have been received in this National Stage							
application from the International Bure * See the attached detailed Office action for a list of	au (PCT Rule 17.2(a)).						
14) Acknowledgment is made of a claim for domestic priority under 35 U.S.C. § 119(e) (to a provisional application).							
 a) ☐ The translation of the foreign language provisional application has been received. 15)☐ Acknowledgment is made of a claim for domestic priority under 35 U.S.C. §§ 120 and/or 121. 							
Attachment(s)							
1) Notice of References Cited (PTO-892) 2) Notice of Draftsperson's Patent Drawing Review (PTO-948) 3) Information Disclosure Statement(s) (PTO-1449) Paper No(s)	5) Notice of Info	nmary (PTO-413) Paper No(s) rmal Patent Application (PTO-152) .					

Art Unit: 2841

Page 2

DETAILED ACTION

Specification

1. The specification is objected to as failing to provide proper antecedent basis for

the claimed subject matter. See 37 CFR 1.75(d)(1) and MPEP § 608.01(o). Correction

of the following is required: Claims 6-7 and 24-25 cite "connection layer" where in

specification there is no mention of a "connection layer," rather the applicant cites a

"connection 44" (page 10, lines 1+). Appropriate correction is required.

Claim Rejections - 35 USC § 102

The following is a quotation of the appropriate paragraphs of 35 U.S.C. 102 that form

the basis for the rejections under this section made in this Office action:

A person shall be entitled to a patent unless -

(b) the invention was patented or described in a printed publication in this or a foreign country or in public use or on sale in this country, more than one year prior to the date of application for patent in the United

States.

1. Claims 1-4, 8, 10, 11, 12, 20-22, 26, 28, 31-41 rejected under 35 U.S.C. 102(b)

as being unpatentable by Appelt U.S. Patent No. 5,900,675. Regarding Claim 1, Appelt

teaches an electronic device comprising a first substrate 630, a second substrate 620,

and a flexible connector 610 attached between first and second substrate by a plurality

of contacts on a first 631-634 and second surface 612, 613 of the connector (Col. 5,

lines 58+; Col. 6, lines 1+; FIG. 6).

Regarding Claims 2, Appelt teaches and electronic device wherein select contacts on the first surface of the connector 631-634 are offset from select contacts on the second surface 612, 613 of the connector (Col. 5, lines 58+; Col. 6, lines 1+; FIG. 6).

Regarding Claim 3, Appelt teaches an electronic device wherein the connector comprises a laminate material (Col. 5, lines 58+; Col. 6, lines 1+; FIG. 6).

Regarding Claim 4, Appelt teaches an electronic device wherein the laminate material comprises a core, a dielectric material surrounding the core, and a solder mask (Col. 5, lines 58+; Col. 6, lines 1+, Col. 7, lines 1+; FIG. 6).

Regarding Claim 8, Applet teaches an electronic device wherein the core comprises a material selected from the group consisting of copper-invar-copper, copper, stainless steel, nickel, iron, and molybdenum (Col. 6, lines 1+, Col. 7, lines 1+).

Regarding Claim 10, Appelt teaches an electronic device wherein the contacts comprise ball grid array connections (Col. 5, lines 58+).

Regarding Claim 11, Appelt teaches an electronic device wherein the first substrate comprises a chip package 630 (Col. 5, lines 58+).

Art Unit: 2841

Regarding Claim 12, Appelt teaches an electronic device wherein the second substrate

comprises a printed circuit board 620 (Col. 5, lines 58+).

Regarding Claim 20, Appelt teaches a connector system comprising a flexible substrate

610, a plurality of contacts 612, 613 formed on a first surface of the substrate, and a

plurality of contacts 631-634 formed on a second surface of the substrate, wherein

select contacts on the first surface of the substrate are offset from select contacts on the

second surface of the substrate (Col. 5, lines 58+; Col. 6, lines 1+; FIG. 6).

Regarding Claim 21, Appelt teaches a connector system wherein the flexible substrate

comprises a laminate material (Col. 5, lines 58+; Col. 6, lines 1+; FIG. 6).

Regarding Claim 22, Appelt teaches a connector system wherein the laminate material

comprises a core, a dielectric material surrounding the core, and a solder mask (Col. 5,

lines 58+; Col. 6, lines 1+; Col. 7, lines 1+; FIG. 6).

Regarding Claim 26, Appelt teaches a connector system wherein the core comprises a

material selected from the group consisting of copper-invar-copper, copper, stainless

steel, nickel, iron, and molybdenum (Col. 6, lines 1+; Col. 7, lines 1+; FIG. 6).

Regarding Claim 28, App - It teaches a connector system wherein the contacts comprise

ball grid array connections (Col. 5, lines 58+; Col. 6, lines 1+).

Application/Control Number: 09/714,373 Page 5

Art Unit: 2841

Regarding Claims 31-41, Appelt teachings inherently possess the methods of

fabricating an electronic device and connector system and the corresponding mounting

and assembling steps needed to construct the apparatus.

Claim Rejections - 35 USC § 103

The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all

obviousness rejections set forth in this Office action:

(a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the

invention was made to a person having ordinary skill in the art to which said subject matter pertains.

Patentability shall not be negatived by the manner in which the invention was made.

1. Claims 5-7 and 23-25 are rejected under 35 U.S.C. 103(a) as being unpatentable

over Appelt U.S. Patent No. 5,900,675 in view of Nguyen U.S. Patent No. 5,477,933.

Regarding Claims 5-6 and 23-24, Appelt teaches a laminate material, but not a laminate

material with through holes. Nguyen teaches a laminate material with plated through

holes 19 that provide electrical connection between at least one contact on the first

surface 12 and one contact on the second surface 23 (Col. 3, lines 25+; FIG. 1, 3). It

would be obvious to a person skilled in the art to provide the laminate material within the

application through holes in order to provide electrical connection between the two

surfaces. By connecting the through holes by a conductive path, the solder contacts are

provided increased strength and durability in protection against detachment as well.

Art Unit: 2841

Page 6

Regarding Claims 7 and 25, Appelt teaches an electronic device with a connection

layer. Appelt does not teach a ground shield over the connection layer. It would be

obvious to a person skilled in the art to include a ground shield over the connection

layer in the present application in order to provide additional impedance control for the

apparatus. By definition, a ground or ground shield protects against any type of static

discharge or a surge in current, therefore including a ground shield to the current

application does not constitute a patentable improvement to the invention.

2. Claims 9 and 27 are rejected under 35 U.S.C. 103(a) as being unpatentable over

Appelt U.S. Patent No. 5,900,675 in view of Distefano U.S. Patent No. 6,309,915 B1.

Appelt teaches a dielectric layer, but does not teach a dielectric layer comprising

polyimide. Distefano teaches a dielectric layer comprising polyimide (Col. 8, lines 55+;

Col. 10, lines 17+). It would be obvious to a person skilled in the art to fabricate the

dielectric layer for the current application out of polyimide. By choosing to have the

dielectric layer comprising polyimide, the flexibility of the dielectric layer is increased

and done so with a common polymeric material such as polyimide.

3. Claims 13-19 and 29-30 are rejected under 35 U.S.C. 103(a) as being

unpatentable over Appelt U.S. Patent No. 5,900,675 in view of Sheppard U.S. Patent

No. 6,284,569 B1. Appelt does not teach a stiffener frame. Sheppard teaches a stiffener

frame 100 providing stiffening for an integrated circuit package further comprising a

Art Unit: 2841

stiffener frame that is attached to and surrounds the perimeter of a substrate or connector, wherein the stiffener is adhesively or removably attached to the substrate, wherein the stiffener frame comprises a material selected from the group consisting of: plastic, metal, and ceramic (Col. 1, lines 57+, Col. 2, lines 6+). It would be obvious to a person skilled in the art to include a stiffener frame to the present application in a manner to not only insure a more rigid and secure electronic device, but to also act as a heat sink in the thermal dissipation of excess heat from the chip package. It can be assumed that as long as the general structure, which comprising the stiffener adhesively attached to a planar laminate by means of an acrylic adhesive material, then the properties of a heat sink will be achieved. Also, by including a stiffener frame, the chance for detachment of substrates between one another and overall damage due to handling is decreased.

Art Unit: 2841

Prior Art

- 1. The prior art made of record and not relied upon is considered pertinent to applicant's disclosure.
 - Jimarez U.S. Patent No. 6,191,952 B1 discloses a flip-chip electronic package comprising a compliant surface layer included on an interconnect carrier including a solder mask, a chip, a substrate, or printed circuit board, and solder balls arranged in a ball grid array to connect the chip to the carrier to the substrate.
 - Susko U.S. Patent No. 6,177,728 B1 discloses an integrated circuit chip device comprising a chip, a carrier comprising a thermoplastic material layer, a glass filled epoxy layer, and an elastic layer, a printed circuit board, and solder balls arranged in a ball grid array to connect the chip to the carrier to the printed circuit board.
 - Caletka U.S. Patent No. 6,104,093 discloses a thermally enhanced flip chip package comprising a chip and a laminate substrate electrically connected to the chip by means of solder balls.

Page 9

Application/Control Number: 09/714,373

Art Unit: 2841

C nclusion

Any inquiry concerning this communication or earlier communications from the examiner should be directed to Michael L. Lindinger whose telephone number is (703) 305-0618. The examiner can normally be reached on Monday-Thursday (7:30-6).

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Jeffrey Gaffin can be reached on (703) 308-3301. The fax phone numbers for the organization where this application or proceeding is assigned are (703) 305-3431 for regular communications and (703) 305-3431 for After Final communications.

Any inquiry of a general nature or relating to the status of this application or proceeding should be directed to the receptionist whose telephone number is (703) 308-0956.

Michael L. Lindinger Patent Examiner Art Unit 2841

MLL November 14, 2001